

1 2 3 4 5 6 7 8

REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

SPECIFICATION

1.MATERIAL:

HOUSING:HIGH TEMPERATURE THERMOPLASTIC

UL 94V-0.COLOR:BLACK

CONTACT: COPPER ALLOY

COVER: COPPER ALLOY

2.PLATING:

UNDERPLATE:NICKEL

CONTACT AREA: GOLD OVER NICKEL(LEAD FREE).

SOLDER AREA: TIN PLATING OVER NICKEL(LEAD FREE).

3.COPLANARITY MUST BE WITHIN 0.10mm

A

B

C

D

E

F

A

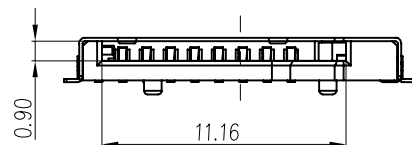
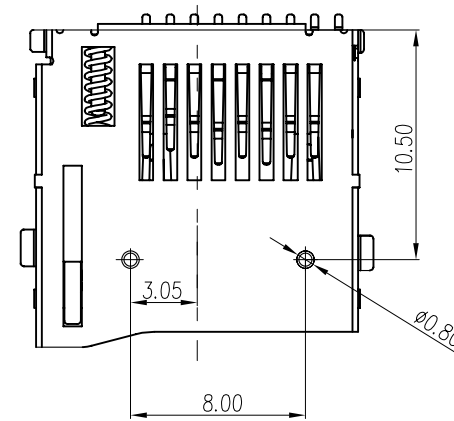
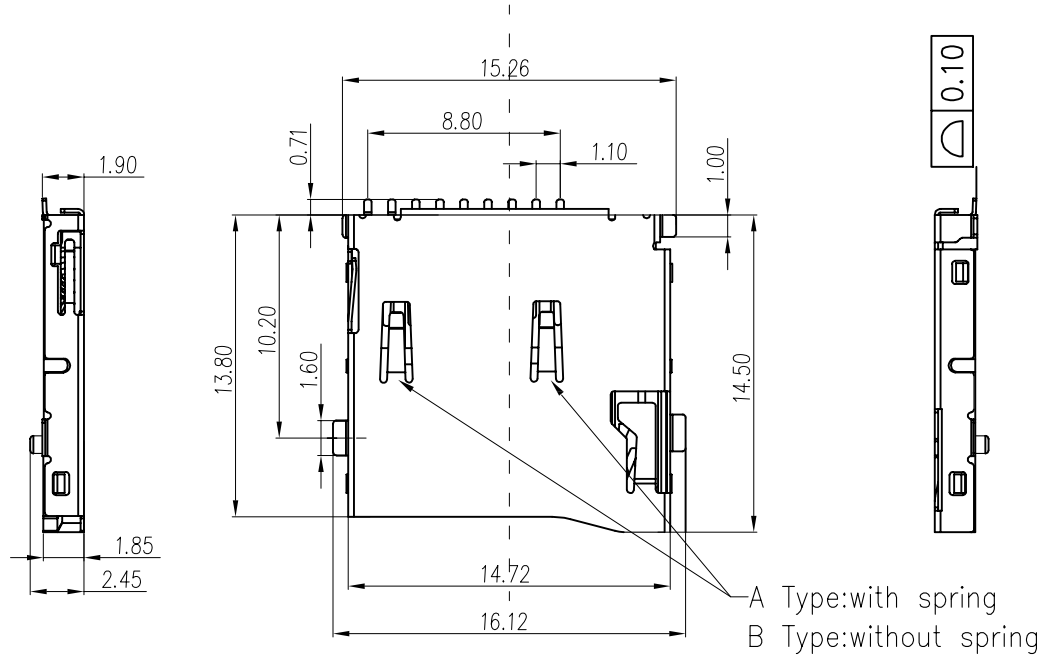
B

C



D

E

F



ROHS Compliant

PRAT NO:		MATERIAL:		 HSI-CHIN ELECTRONICS CO.,LTD	
MODEL NO:		FINSH:			
UNIT: mm	SAZE: A4	COLOR:	PART NAME:  Mciro SD Push 1.9h Conn		
TOLERANCE UNSPECIFIED		DR: 劉祖惠 '11/10/20			
.X ±0.30		CHK: Kevin '11/10/20	DWG NO: OD-S/A-631		REV. A0
.XX ±0.20		APP: Kent '11/10/20	SCALE: 1:1		SHEET: 1 of 2
.XXX ±0.10					
ANG ±1°					

1 2 3 4 5 6 7 8

1

2

3

4

5

6

7

8

REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

A

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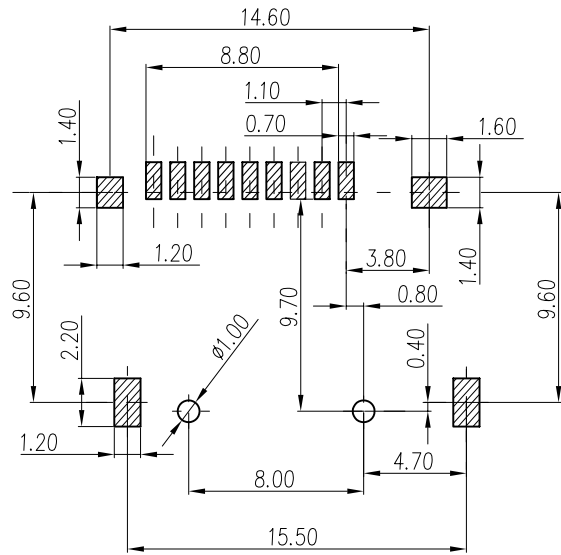
D

E

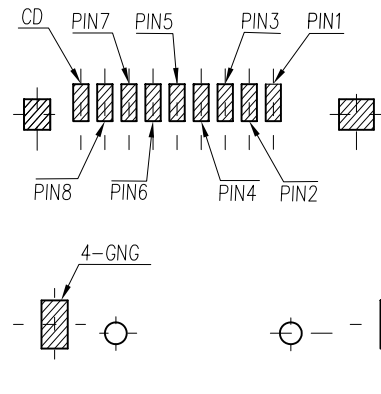
E

F

F




P.C.B LAYOUT  
(TOLERANCE ±0.05)



PIN ASSIGNMENT

PIN NO.	PIN ASSIGNMENT
PIN1	DAT2
PIN2	CD/DAT3 <sup>2</sup>
PIN3	CMD
PIN4	VDD
PIN5	CLK
PIN6	VSS
PIN7	DAT0
PIN8	DAT1

ROHS Compliant

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MODEL NO:	FINSH:		
UNIT: mm	SAZE: A4	COLOR:	PART NAME:
TOLERANCE UNSPECIFIED	DR: 劉祖惠 '11/10/20	Mciro SD Push 1.9h Conn	
.X ±0.30	CHK: Kevin '11/10/20	DWG NO: OD-S/A-631	REV. A0
.XX ±0.20	APP: Kent '11/10/20	SCALE: 1:1	SHEET: 2 of 2
.XXX ±0.10			
ANG ±1°			